



200mW, Low V_F SMD Schottky Barrier Diode

FEATURES

- Fast switching device(t_{rr}<4.0nS)
- Surface mount device type
- Moisture sensitivity level 1
- Pb free and RoHS compliant
- Matte Tin(Sn) lead finish with Nickel(Ni) underplate
- Green compound (Halogen free) with suffix "G" on packing code and prefix "G" on date code

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SOD-323F

ROHS

MECHANICAL DATA

- Case: Flat lead SOD-323 small outline plastic package
- Terminal : Matte tin plated, lead free, solderable per MIL-STD-202, method 208 guaranteed
- High temperature soldering guaranteed: 260°C/10s
- Polarity: Indicated by cathode band
- Weight : $4.85 \pm 0.5 \text{ mg}$

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted)					
PARAMETER	SYMBOL	VALUE	UNIT		
Peak Repetitive Reverse Voltage	V_{RRM}	30	V		
Mean Forward Current	I _O	500	mA		
Non-Repetitive Peak Forward Surge Current @t=8.3ms	I _{FSM}	5	А		
Power Dissipation	P _D	200	mW		
Thermal Resistance form Junction to Ambient	R_{thjA}	426	°C/W		
Junction Temperature	T _J	125	°C		
Storage Temperature Range	T _{STG}	- 65 to + 125	°C		

PARAMETER	TEST CONDITION	SYMBOL	MIN	MAX	UNIT
Reverse Breakdown Voltage	at I _R = 500μA	$V_{(BR)}$	30		V
	at V _R = 15 V			80	
Reverse Leakage Current	at $V_R = 20 \text{ V}$	I _R		100	μA
	at $V_R = 30 \text{ V}$			500	
Farment Valtage	at I _F = 100mA			0.36	
Forward Voltage	at I _F = 500mA	V _F		0.47	V
Junction Capacitance	V _R =0, f=1.0MHz	СЈ		58	pF



RATINGS AND CHARACTERISTICS CURVES

(TA=25°C unless otherwise noted)

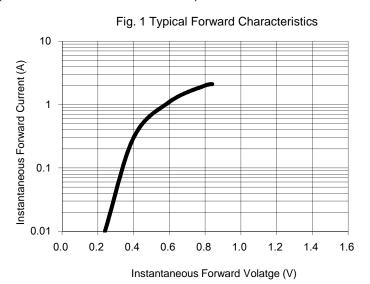


Fig. 3 Admissible Power Dissipation Curve

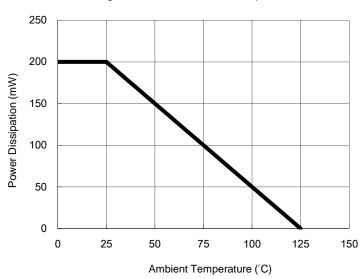
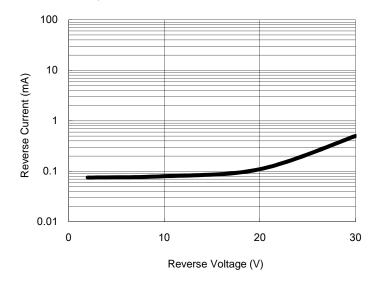


Fig. 5 Typical Reverse Characteristics



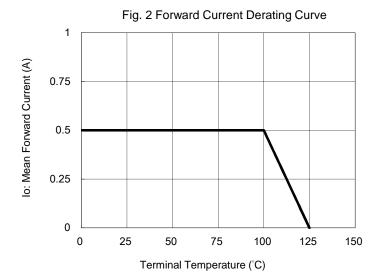
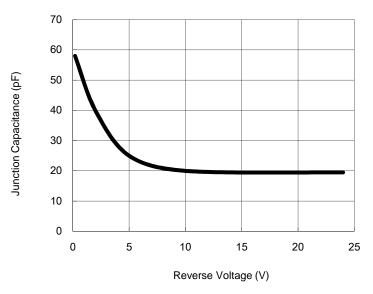


Fig. 4 Typical Junction Capacitance







ORDERING INFORMATION						
PART NO.	MANUFACTURE CODE	PACKING CODE	GREEN COMPOUND CODE	PACKAGE	PACKING	MARKING
B0530WS	(Note)	RR	G	SOD-323F	3K / 7" Reel	B3

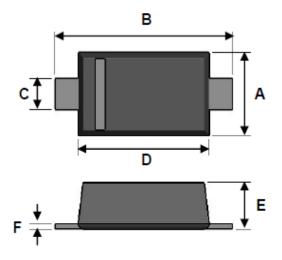
Note: Manufacture special control, if empty means no special control requirement.

EXAMPLE						
PREFERRED P/N	PART NO.	MANUFACTURE CODE	PACKING CODE	GREEN COMPOUND CODE	DESCRIPTION	
B0530WS RRG	B0530WS		RR	G	Green compound	
B0530WS-L0 RRG	B0530WS	L0	RR	G	Green compound	





DIMENSIONS



DIM.	Unit	(mm)	Unit (inch)		
	Min	Max	Min	Max	
Α	1.15	1.35	0.045	0.053	
В	2.30	2.80	0.091	0.110	
С	0.25	0.40	0.010	0.016	
D	1.60	1.80	0.063	0.071	
Е	0.80	1.10	0.031	0.043	
F	0.05	0.25	0.002	0.010	





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